## Stacked MCP (Multi-Chip Package) FLASH MEMORY \& FCRAM CMOS

## 64M (×16) Page FLASH MEMORY \& 32M (×16) Mobile FCRAM ${ }^{\text {TM }}$

## MB84VP23481FK-70

## ■ FEATURES

- Power Supply Voltage of 2.7 V to 3.1 V
- High Performance

25 ns maximum page read access time, 65 ns maximum random access time (Flash)
20 ns maximum page read access time, 70 ns maximum random access time (FCRAM)

- Operating Temperature
$-30^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- Package 65-ball FBGA
(Continued)
PRODUCT LINEUP

|  | Flash | FCRAM |
| :--- | :---: | :---: |
| Supply Voltage (V) | $\mathrm{Vccf}^{*}=3.0 \mathrm{~V}_{-0.3}^{+0.1 \mathrm{~V}}$ | $\mathrm{~V}_{\mathrm{ccr}} \mathrm{V}^{*}=3.0 \mathrm{~V}_{-0.3}^{+0.1 \mathrm{~V}}$ |
| Max Random Address Access Time (ns) | 65 | 70 |
| Max Page Address Access Time (ns) | 25 | 20 |
| Max $\overline{\text { CE Access Time (ns) }}$ | 65 | 70 |
| Max $\overline{\text { OE Access Time (ns) }}$ | 25 | 40 |

*: Both $\mathrm{V}_{\text {ccf }}$ and V cor must be the same level when either part is being accessed.

## PACKAGE

| 65-ball plastic FBGA |
| :--- |
| (BGA-65P-M01) |

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## MB84VP23481FK-70

## (Continued)

## - FLASH MEMORY

## - Simultaneous Read/Write Operations (Dual Bank)

- FlexBank ${ }^{\text {TM }}$ *

Bank A: 8 Mbit ( $8 \mathrm{~KB} \times 8$ and $64 \mathrm{~KB} \times 15$ )
Bank B: 24 Mbit ( $64 \mathrm{~KB} \times 48$ )
Bank C: 24 Mbit ( $64 \mathrm{~KB} \times 48$ )
Bank D: 8 Mbit ( $8 \mathrm{~KB} \times 8$ and $64 \mathrm{~KB} \times 15$ )

- 8 words Page
- Compatible with JEDEC-standard commands Uses same software commands as E2PROMs
- Minimum 100,000 Program/Erase Cycles
- Sector Erase Architecture

Eight 8 Kbytes, a hundred twenty-six 64 Kbytes, eight 8 Kbytes sectors.
Any combination of sectors can be concurrently erased. Also supports full chip erase

- Dual Boot Block

Sixteen to 8Kbytes boot block sectors, eight at the top of the address range and eight at the bottom of the address range

- HiddenROM Region

256 byte of HiddenROM, accessible through a new "HiddenROM Enable" command sequence
Factory serialized and protected to provide a secure electronic serial number (ESN)

- WP/ACC Input Pin

At $\mathrm{V}_{\mathrm{L}}$, allows protection of "outermost" $2 \times 4 \mathrm{~K}$ words on both ends of boot sectors, regardless of sector protection/unprotection status
At $\mathrm{V}_{\mathrm{I}}$, allows removal of boot sector protection
At $V_{A C C}$, increases program performance

- Embedded Erase ${ }^{T M}{ }^{* 2}$ Algorithms

Automatically preprograms and erases the chip or any sector

- Embedded Program ${ }^{\text {TM }}{ }^{* 2}$ Algorithms

Automatically writes and verifies data at specified address

- Data Polling and Toggle Bit feature for Detection of Program or Erase Cycle Completion
- Ready/Busy Output (RY/BY)

Hardware method for detection of program or erase cycle completion

- Automatic Sleep Mode

When addresses remain stable, the device automatically switches itself to low power mode

- Program Suspend/Resume

Suspends the program operation to allow a read in another byte

- Erase Suspend/Resume

Suspends the erase operation to allow a read data and/or program in another sector within the same device

- New Sector Protection

Persistent Sector Protection
Password Sector Protection

- Please refer to "MBM29QM64DF" Datasheet in Detailed Function


## (Continued)

- FCRAM ${ }^{\text {TM *3 }}$
- Power Dissipation

Operating : 30 mA Max
Standby : $100 \mu \mathrm{~A}$ Max

- Power Down Mode

Sleep : $10 \mu \mathrm{~A}$ Max
4M Partial : $45 \mu \mathrm{~A}$ Max
8M Partial : $55 \mu \mathrm{~A}$ Max
16M Partial: $70 \mu \mathrm{~A}$ Max

- Power Down Control by CE2r
- Byte Write Control: $\overline{\mathrm{LB}}\left(\mathrm{DQ}_{7}\right.$ to $\left.\mathrm{DQ}_{0}\right), \overline{\mathrm{UB}}\left(\mathrm{DQ}_{15}\right.$ to $\left.\mathrm{DQ}_{8}\right)$
- 8 words Page Access Capability
*1: FlexBank ${ }^{\top M}$ is a trademark of Fujitsu Limited, Japan.
*2: Embedded Erase ${ }^{\text {TM }}$ and Embedded Program ${ }^{\text {TM }}$ are trademarks of Advanced Micro Devices, Inc.
*3: Mobile FCRAM ${ }^{\text {™ }}$ is a trademark of Fujitsu Limited, Japan.


## MB84VP23481FK-70

## PIN ASSIGNMENT

(Top View)
Marking Side

(BGA-65P-M01)

## - PIN DESCRIPTION

| Pin name | Input/ <br> Output | Description |
| :---: | :---: | :--- |
| $\mathrm{A}_{20}$ to $\mathrm{A}_{0}$ | I | Address Inputs (Common) |
| $\mathrm{A}_{21}$ | I | Address Input (Flash) |
| $\mathrm{DQ}_{15}$ to DQ $\mathrm{D}_{0}$ | I/O | Data Inputs/Outputs (Common) |
| $\overline{\mathrm{CEf}}$ | I | Chip Enable (Flash) |
| $\overline{\mathrm{CE} 1 \mathrm{r}}$ | I | Chip Enable (FCRAM) |
| CE 2 r | I | Chip Enable (FCRAM) |
| $\overline{\mathrm{OE}}$ | I | Output Enable (Common) |
| $\overline{\mathrm{WE}}$ | I | Write Enable (Common) |
| $\mathrm{RY} / \overline{\mathrm{BY}}$ | O | Ready/Busy Output (Flash) Open Drain Output |
| $\overline{\mathrm{UB}}$ | I | Upper Byte Control (FCRAM) |
| $\overline{\mathrm{LB}}$ | I | Lower Byte Control (FCRAM) |
| $\overline{\mathrm{RESET}}$ | I | Hardware Reset Pin/Sector Protection Unlock (Flash) |
| $\overline{\mathrm{WP} / A C C ~}$ | I | Write Protect / Acceleration (Flash) |
| N.C. | - | No Internal Connection |
| Vss | Power | Device Ground (Common) |
| Vccf | Power | Device Power Supply (Flash) |
| Vccr | Power | Device Power Supply (FCRAM) |

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## BLOCK DIAGRAM



## ■ DEVICE BUS OPERATIONS

| Operation*1, *2 | $\overline{\text { CEf }}$ | CE1r | CE2r | OE | WE | $\overline{\text { LB }}$ | $\overline{\text { UB }}$ | A 21 to Ao | $\begin{gathered} \mathrm{DQ}_{7} \text { to } \\ \mathrm{DQ}_{0} \end{gathered}$ | $\begin{gathered} \mathrm{DQ}_{15} \text { to } \\ \mathrm{DQ}_{8} \end{gathered}$ | RESET | $\overline{W P} / A C C^{* 9}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Full Standby | H | H | H | X | X | X | X | X | High-Z | High-Z | H | X |
| Output Disable*3 | H | L | H | H | H | X | X | X*8 | High-Z | High-Z | H | X |
|  | L | H |  |  |  |  |  |  |  |  |  |  |
| Read from Flash*4 | L | H | H | L | H | X | X | Valid | Dout | Dout | H | X |
| Write to Flash | L | H | H | H | L | X | X | Valid | Din | Din | H | X |
| Read from FCRAM | H | L | H | L | H | L | L | Valid | Din | Din | H | X |
|  |  |  |  |  |  | H | L |  | High-Z | Din |  |  |
|  |  |  |  |  |  | L | H |  | Din | High-Z |  |  |
| FCRAM No Read | H | L | H | L | H | H | H | Valid | High-Z | High-Z | H | X |
| Write to FCRAM | H | L | H | $\mathrm{H}^{\star 7}$ | L | L | L | Valid | Din | Din | H | X |
|  |  |  |  |  |  | H | L |  | High-Z | Din |  |  |
|  |  |  |  |  |  | L | H |  | Din | High-Z |  |  |
| FCRAM No Write | H | L | H | $\mathrm{H}^{* 7}$ | L | H | H | Valid | High-Z | High-Z | H | X |
| Flash Temporary Sector Group Unprotection*5 | X | X | X | X | X | X | X | X | X | X | VID | X |
| Flash Hardware Reset | X | H | H | X | X | X | X | X | High-Z | High-Z | L | X |
| Flash Boot Block Sector Write Protection | X | X | X | X | X | X | X | X | X | X | X | L |
| FCRAM Power Down*6 | X | X | L | X | X | X | X | X | X | X | X | X |

Legend: $\mathrm{L}=\mathrm{V}_{\mathrm{IL}}, \mathrm{H}=\mathrm{V}_{\mathrm{H}}, \mathrm{X}$ can be either $\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\text {н }}$, High-Z $=$ High Impedance.
See ■DC CHARACTERISTICS for voltage levels.
*1: Other operations except for indicated this column are inhibited.
*2 : Do not apply for two or more states of the following conditions at the same time;

- $\overline{\mathrm{CEf}}=\mathrm{V} \mathrm{IL}$
- $\overline{\mathrm{CE}} 1 \mathrm{r}=\mathrm{V}_{\mathrm{IL}}$ and $\mathrm{CE} 2 \mathrm{r}=\mathrm{V}_{\mathrm{H}}$
*3 : Should not be kept FCRAM Output Disable condition longer than $1 \mu \mathrm{~s}$.
*4 : $\overline{W E}$ can be $V_{\text {IL }}$ if $\overline{O E}$ is $V_{I L}, \overline{O E}$ at $V_{\text {IH }}$ initiates the write operations.
*5: It is also used for the extended sector group protections.
*6 : FCRAM Power Down mode can be entered from Standby state and all DQ pins are in High-Z state. Data retention depends on the selection of Power Down Program. Please refer to "Power Down Program" in FCRAM Characteristics part.
*7: $\overline{\mathrm{OE}}$ can be VILduring Write operation if the following conditions are satisfied;

1) Write pulse is initiated by $\overline{\mathrm{CE}} 1 \mathrm{r}$ (refer to $\overline{\mathrm{CE}} 1 \mathrm{r}$ Controlled Write timing), or cycle time of the previous operation cycle is satisfied.
2) $\overline{O E}$ stays VIL during Write cycle.
*8 : Can be either Vıı or Vін but must be valid before Read or Write.
*9 : Protect "outer most" $2 \times 8 \mathrm{~K}$ bytes ( 4 words) on both ends of the boot block sectors.

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## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Rating |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |
| Storage Temperature | Tstg | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Ambient Temperature with Power Applied | TA | -30 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Voltage with Respect to Ground All pins except RESET, WP/ACC *1 | Vin, Vout | -0.3 | Vccf +0.3 | V |
|  |  |  | $\mathrm{Vccr}+0.3$ | V |
| Vccf/Vccr Supply *1 | Vccf, Vccr | -0.3 | +3.3 | V |
| RESET *2 | Vin | -0.5 | + 13.0 | V |
| $\overline{W P} /$ ACC *3 | Vin | -0.5 | +10.5 | V |

*1 Minimum DC voltage on input or I/O pins is -0.3 V . During voltage transitions, input or I/O pins may undershoot Vss to -1.0 V for periods of up to 5 ns . Maximum DC voltage on input or $\mathrm{I} / \mathrm{O}$ pins is $\mathrm{Vccf}+0.3 \mathrm{~V}$ or $\mathrm{Vccr}+0.3 \mathrm{~V}$. During voltage transitions, input or I/O pins may overshoot to $\mathrm{Vccf}+2.0 \mathrm{~V}$ or $\mathrm{Vccr}+1.0 \mathrm{~V}$ for periods of up to 5 ns .
*2: Minimum DC input voltage on RESET pin is -0.5 V . During voltage transitions RESET pins may undershoot Vss to -2.0 V for periods of up to 20 ns . Voltage difference between input and supply voltage (Vin-Vccf) does not exceed +9.0 V . Maximum DC input voltage on RESET pins is +13.0 V which may overshoot to +14.0 V for periods of up to 20 ns .
*3: Minimum DC input voltage on $\bar{W} /$ ACC pin is -0.5 V . During voltage transitions, $\overline{\mathrm{WP}} / \mathrm{ACC}$ pin may undershoot Vss to -2.0 V for periods of up to 20 ns . Maximum DC input voltage on $\overline{\mathrm{WP}} / \mathrm{ACC}$ pin is +10.5 V which may overshoot to +12.0 V for periods of up to 20 ns , when V cff is applied.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## ■ RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Value |  | Unit |
| :--- | :---: | :---: | :---: | :---: |
|  |  | Min | +85 |  |
| Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -30 | +3.1 | V |
| Vccf/Vccr Supply Voltages | Vccf, $\mathrm{V}_{\text {ccr }}$ | +2.7 |  |  |

Note: Operating ranges define those limits between which the functionality of the device is guaranteed.
WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

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## ■ DC CHARACTERISTICS

| Parameter | Symbol | Conditions |  | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| Input Leakage Current | ILI | V in $=$ V ss to Vccf , $\mathrm{V}_{\text {ccr }}$ |  | -1.0 | - | +1.0 | $\mu \mathrm{A}$ |
| Output Leakage Current | ILo | Vout = Vss to Vccf, Vccr, Output Disable |  | -1.0 | - | +1.0 | $\mu \mathrm{A}$ |
| RESET Inputs Leakage Current (Flash) | ILit | V ccf $=\mathrm{V}$ ccf Max, $\overline{\mathrm{RESET}}=12.5 \mathrm{~V}$ |  | - | - | 35 | $\mu \mathrm{A}$ |
| $\overline{W P} / A C C$ Acceleration Program Current (Flash) | ILIA | V ccf $=\mathrm{V}$ ccf $\mathrm{Max}, \overline{\mathrm{WP}} / \mathrm{ACC}=\mathrm{V}_{\text {Acc }} \mathrm{Max}$ |  | - | - | 20 | mA |
| Flash Vcc Active Current *1,*6 | loct | $\overline{\mathrm{CEf}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}, \mathrm{f}=10 \mathrm{MHz}$ |  | - | - | 45 | mA |
| (Initial/Random Read) | Iccif | $\overline{\mathrm{CEf}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}, \mathrm{f}=5 \mathrm{MHz}$ |  | - | - | 20 | mA |
| Flash Vcc Active Current *2 | Iccaf | $\overline{\mathrm{CE}} \mathrm{f}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}$ |  | - | - | 25 | mA |
| Flash Vcc Current (Page Mode) *9,*6 | Icc3f | $\overline{\mathrm{CEf}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}, \mathrm{f}=40 \mathrm{MHz}$ |  | - | - | 10 | mA |
| Flash Vcc Active Current*5,*6 (Read-While-Program) | Icc4f | $\overline{\mathrm{CE}} \mathrm{f}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}$ |  | - | - | 45 | mA |
| Flash Vcc Active Current*5,*6 (Read-While-Erase) | Iccsf | $\overline{\mathrm{CEf}}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}$ |  | - | - | 45 | mA |
| Flash Vcc Active Current*5,*6 <br> (Erase-Suspend-Program) | Iccef | $\overline{\mathrm{CE}} \mathrm{f}=\mathrm{V}_{\mathrm{IL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IH}}$ |  | - | - | 25 | mA |
| Flash Vcc Current (Standby) *6 | Isbif | $\begin{aligned} & \mathrm{V} \text { ccf }=\mathrm{V} \text { ccf } \mathrm{Max}, \overline{\mathrm{CEf}}=\mathrm{V} \operatorname{ccf} \pm 0.3 \mathrm{~V} \\ & \mathrm{RESET}=\mathrm{V} \text { ccf } \pm 0.3 \mathrm{~V}, \\ & \text { WP/ACC }=\mathrm{V} \text { ccf } \pm 0.3 \mathrm{~V} \end{aligned}$ |  | - | 1 | 5 | $\mu \mathrm{A}$ |
| Flash V ${ }_{\text {cc }}$ Current (Standby, Reset) *6 | Isb2f | V ccf $=\mathrm{V}$ ccf $\mathrm{Max}, \overline{\mathrm{RESET}}=\mathrm{V}$ ss $\pm 0.3 \mathrm{~V}$ |  | - | 1 | 5 | $\mu \mathrm{A}$ |
| Flash Vcc Current (Automatic Sleep Mode)*3 | Isbsf | Vccf $=$ Vccf Max, $\overline{\mathrm{CE}} \mathrm{f}=\mathrm{V}$ ss $\pm 0.3 \mathrm{~V}$, RESET $=\mathrm{Vccf} \pm 0.3 \mathrm{~V}$, <br> Vin $=\mathrm{Vccf} \pm 0.3 \mathrm{~V}$ or $\mathrm{V} \operatorname{ssf} \pm 0.3 \mathrm{~V}$ |  | - | 1 | 5 | $\mu \mathrm{A}$ |
| FCRAM V cc Active Current *6, *8 | Iccir | $\begin{aligned} & \mathrm{V}_{\mathrm{ccr}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max}, \\ & \mathrm{CE} 1 \mathrm{M}=\mathrm{V}_{\mathrm{IL}, \mathrm{C}} \mathrm{CE} 2 \mathrm{r}=\mathrm{V}_{\mathrm{HH}}, \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{HH}} \text { Or } \mathrm{V}_{\mathrm{IL}}, \\ & \text { lout }^{2} \mathrm{~mA}^{* 7} \end{aligned}$ | trc / twc $=$ Min | - | - | 30 | mA |
|  | Iccar |  | trc / twc $=1 \mu \mathrm{~s}$ | - | - | 3 |  |
| FCRAM Vcc Page Read Current *6, *8 | Iccar | $\begin{aligned} & \mathrm{V}_{\mathrm{ccr}}=\mathrm{V}_{\mathrm{ccr}} \operatorname{Max}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}}, \\ & \mathrm{CE} 1 \mathrm{r}=\mathrm{V}_{\mathrm{LL}}, \mathrm{CE} 2 \mathrm{r}=\mathrm{V}_{\mathrm{IH}} \text { lout }=0 \mathrm{~mA}, \\ & \text { trac }=\text { Min } \end{aligned}$ |  | - | - | 10 | mA |
| FCRAM Vcc Standby Current *6, *8 | Isbir | $\begin{aligned} & \text { Vccr }=\mathrm{V}_{\mathrm{ccr}} \text { Max, } \\ & \mathrm{V}_{\mathrm{IN}} \leq 0.2 \mathrm{~V} \text { or } \geq \mathrm{V} \text { ccr }-0.2 \mathrm{~V} \\ & \mathrm{CE} 1 \mathrm{~V} \geq \mathrm{V} \text { ccr }-0.2 \mathrm{~V}, \mathrm{CE} 2 \mathrm{r} \geq \mathrm{Vccr}-0.2 \mathrm{~V} \end{aligned}$ |  | - | - | 100 | $\mu \mathrm{A}$ |
| FCRAM Vcc Power Down Current *6, *8 | Idopsr | $\begin{aligned} & V_{\text {ccr }}=V_{\text {ccr }} \operatorname{Max}, \\ & C E 2 r \leq 0.2 V \\ & V_{\text {IN }}=V_{\text {IH }} \text { or } V_{\text {IL }} \end{aligned}$ | Sleep | - | - | 10 | $\mu \mathrm{A}$ |
|  | Idmp4r |  | 4M Partial | - | - | 45 | $\mu \mathrm{A}$ |
|  | Idopsr |  | 8M Partial | - | - | 55 | $\mu \mathrm{A}$ |
|  | IdDP16r |  | 16M Partial | - | 一 | 70 | $\mu \mathrm{A}$ |

(Continued)

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(Continued)

| Parameter | Symbol | Conditions |  | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| Input Low Level | VIL | - |  | -0.3 | - | $\underset{* 6}{\mathrm{~V}_{\mathrm{cc}} \times 0.2}$ | V |
| Input High Level | VIH | - |  | $\mathrm{V}_{\mathrm{cc}} \times 0.8$ | - | $\underset{* 6}{\mathrm{~V}_{\mathrm{cc}}+0.2}$ | V |
| Voltage for Sector Protection, and Temporary Sector Unprotection ( $\overline{\text { RESET }}{ }^{* 4}$ | VII | - |  | 11.5 | 12 | 12.5 | V |
| Voltage for $\overline{\mathrm{WP}} / \mathrm{ACC}$ Sector Protection/Unprotection and Program Acceleration *4 | Vacc | - |  | 8.5 | 9.0 | 9.5 | V |
| Output Low Voltage Level | Voıf | $\mathrm{V}_{\text {ccf }}=\mathrm{V}_{\text {ccf }} \mathrm{Min}$, lol $=4.0 \mathrm{~mA}$ | Flash | - | - | 0.4 | V |
|  | Vour | V ccr $=\mathrm{V}_{\text {ccr }} \mathrm{Min}$, lol $=1.0 \mathrm{~mA}$ | FCRAM | - | - | 0.4 | V |
| Output High Voltage Level | Vorf | $\mathrm{V}_{\text {cof }}=\mathrm{V}_{\text {ccf }} \mathrm{Min}$, loh $=-2.0 \mathrm{~mA}$ | Flash | 2.4 | - | - | V |
|  | Vohr | $\mathrm{V}_{\text {cor }}=\mathrm{V}_{\text {ccr }}$ Min, loh= $=0.5 \mathrm{~mA}$ | FCRAM | 2.4 | - | - | V |
| Flash Low Vccf Lock-Out Voltage | Vıко | - |  | 2.3 | 2.4 | 2.5 | V |

*1: The Icc current listed includes both the DC operating current and the frequency dependent component.
*2: Icc active while Embedded Algorithm (program or erase) is in progress.
*3: Automatic sleep mode enables the low power mode when address remains stable for 150 ns .
*4: Applicable for only Vccf applying.
*5: Embedded Algorithm (program or erase) is in progress. (@5 MHz)
*6: Vcc indicates lower of $\mathrm{Vccf}^{\text {cor }} \mathrm{V}$ ccr.
*7: FCRAM Characteristics are measured after following POWER-UP timing.
*8: lout depends on the output load conditions.
${ }^{*} 9$ : Address except $\mathrm{A}_{2}, \mathrm{~A}_{1}$ and $\mathrm{A}_{0}$ are fixed.

## - AC CHARACTERISTICS

- CE Timing

| Parameter | Symbol |  | Condition | Value |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | JEDEC | Standard |  | Min | Max |  |
| $\overline{\text { CE Recover Time }}$ | - | tocr | - | 0 | - | ns |
| $\overline{\text { CE Hold Time }}$ | - | tchold | - | 3 | - | ns |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High to $\overline{\mathrm{WE}}$ Invalid time for Standby Entry | - | tchwx | - | 10 | - | ns |

- Timing Diagram for alternating RAM to Flash

- Flash Characteristics

Please refer to " 64 M PAEG FLASH MEMORY CHARACTERISTICS for MCP".

## - FCRAM Characteristics

Please refer to " $\mathbf{\square} 32$ M FCRAM CHARACTERISTICS for MCP".

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## 64 M PAEG FLASH MEMORY CHARACTERISTICS for MCP

## 1. Flexible Sector-erase Architecture on FLASH MEMORY

- Sixteen 4 K words, and one hundred twenty-six 32 K words.
- Individual-sector, multiple-sector, or bulk-erase capability.

- FlexBank ${ }^{\text {TM }}$ Architecture

| Bank <br> Splits | Bank 1 |  | Bank 2 |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Volume | Combination | Volume | Combination |
| 1 | 8 Mbit | Bank A | 56 Mbit | Remainder (Bank B, C, D) |
| 2 | 24 Mbit | Bank B | 40 Mbit | Remainder (Bank A, C, D) |
| 3 | 24 Mbit | Bank C | 40 Mbit | Remainder (Bank A, B, D) |
| 4 | 8 Mbit | Bank D | 56 Mbit | Remainder (Bank A, B, C) |

- Example of Virtual Banks Combination

| Bank Splits | Bank 1 |  |  | Bank 2 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Volume | Combination | Sector Size | Volume | Combination | Sector Size |
| 1 | 8 Mbit | Bank A | $8 \times 8$ Kbyte/4 Kword $+$ $15 \times 64$ Kbyte/32 Kword | 56 Mbit | $\begin{gathered} \hline \text { Bank B } \\ + \\ \text { Bank C } \\ + \\ + \\ \text { Bank D } \end{gathered}$ | $8 \times 8$ Kbyte/4 Kword <br> $111 \times 64$ Kbyte/32 Kword |
| 2 | 16 Mbit | Bank A <br> Bank D | $\begin{gathered} 16 \times 8 \text { Kbyte } / 4 \text { Kword } \\ + \\ 30 \times 64 \text { Kbyte } / 32 \text { Kword } \end{gathered}$ | 48 Mbit | $\begin{gathered} \hline \text { Bank B } \\ + \\ \text { Bank C } \end{gathered}$ | $96 \times 64 \mathrm{Kbyte} / 32 \mathrm{Kword}$ |
| 3 | 24 Mbit | Bank B | $48 \times 64 \mathrm{Kbyte} / 32 \mathrm{Kword}$ | 40 Mbit | $\begin{gathered} \hline \text { Bank A } \\ + \\ \text { Bank C } \\ + \\ \text { Bank D } \end{gathered}$ | $16 \times 8$ Kbyte/4 Kword $78 \times 64$ Kbyte/32 Kword |
| 4 | 32 Mbit | $\begin{gathered} \hline \text { Bank A } \\ + \\ \text { Bank B } \end{gathered}$ | $8 \times 8$ Kbyte/4 Kword $63 \times 64$ Kbyte/32 Kword | 32 Mbit | $\begin{gathered} \hline \text { Bank C } \\ + \\ \text { Bank D } \end{gathered}$ | $8 \times 8$ Kbyte/4 Kword $+$ $63 \times 64$ Kbyte/32 Kword |

Note : When multiple sector erase over several banks is operated, the system cannot read out of the bank to which a sector being erased belongs. For example, suppose that erasing is taking place at both Bank A and Bank B, neither Bank A nor Bank B is read out (they would output the sequence flag once they were selected.) Meanwhile the system would get to read from either Bank C or Bank D.

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- Simultaneous Operation

| Case | Bank 1 Status | Bank 2 Status |
| :---: | :---: | :---: |
| 1 | Read mode | Read mode |
| 2 | Read mode | Autoselect mode |
| 3 | Read mode | Program mode |
| 4 | Read mode | Erase mode ${ }^{*}$ |
| 5 | Autoselect mode | Read mode |
| 6 | Program mode | Read mode |
| 7 | Erase mode * | Read mode |

*: By writing erase suspend command on the bank address of sector being erased, the erase operation gets suspended so that it enables reading from or programming the remaining sectors.
Note: Bank 1 and Bank 2 are divided for the sake of convenience at Simultaneous Operation. Actually, the Bank consists of 4 banks, Bank A, Bank B, Bank C and Bank D. Bank Address (BA) meant to specify each of the Banks.

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- Sector Address Tables

| Bank | Sector | Sector Address |  |  |  |  |  |  |  |  |  | Address Range <br> Word Mode |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Bank Address |  |  |  |  |  |  |  |  |  |  |
|  |  | A21 | A20 | A19 $^{1}$ | A18 | A17 | $\mathrm{A}_{16}$ | A15 | $\mathrm{A}_{14}$ | $\mathrm{A}_{13}$ | $\mathrm{A}_{12}$ |  |
| Bank A | SA0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 000000h to 000FFFh |
|  | SA1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 001000h to 001FFFh |
|  | SA2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 002000h to 002FFFh |
|  | SA3 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 003000h to 003FFFh |
|  | SA4 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 004000h to 004FFFh |
|  | SA5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 005000h to 005FFFh |
|  | SA6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 006000h to 006FFFh |
|  | SA7 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 007000h to 007FFFh |
|  | SA8 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | X | X | X | 008000h to 00FFFFh |
|  | SA9 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | X | X | X | 010000h to 017FFFh |
|  | SA10 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | X | X | X | 018000h to 01FFFFh |
|  | SA11 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | X | X | X | 020000h to 027FFFh |
|  | SA12 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | X | X | X | 028000h to 02FFFFh |
|  | SA13 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | X | X | X | 030000h to 037FFFh |
|  | SA14 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | X | X | X | 038000h to 03FFFFh |
|  | SA15 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | X | X | X | 040000h to 047FFFh |
|  | SA16 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | X | X | X | 048000h to 04FFFFh |
|  | SA17 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | X | X | X | 050000h to 057FFFh |
|  | SA18 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | X | X | X | 058000h to 05FFFFh |
|  | SA19 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | X | X | X | 060000h to 067FFFh |
|  | SA20 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | X | X | X | 068000h to 06FFFFh |
|  | SA21 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | X | X | X | 070000h to 077FFFh |
|  | SA22 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | X | X | X | 078000h to 07FFFFh |

(Continued)

| Bank | Sector | Sector Address |  |  |  |  |  |  |  |  |  | Address Range <br> Word Mode |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Bank Address |  |  |  |  |  |  |  |  |  |  |
|  |  | A21 | A20 | $\mathrm{A}_{19}$ | A18 | A17 | A16 | A15 | $\mathrm{A}_{14}$ | $\mathrm{A}_{13}$ | $\mathrm{A}_{12}$ |  |
| Bank B | SA23 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | X | X | X | 080000h to 087FFFh |
|  | SA24 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | X | X | X | 088000h to 08FFFFh |
|  | SA25 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | X | X | X | 090000h to 097FFFh |
|  | SA26 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | X | X | X | 098000h to 09FFFFh |
|  | SA27 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | X | X | X | 0A0000h to 0A7FFFh |
|  | SA28 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | X | X | X | 0A8000h to 0AFFFFh |
|  | SA29 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | X | X | X | 0B0000h to 0B7FFFh |
|  | SA30 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | X | X | X | 0B8000h to 0BFFFFh |
|  | SA31 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | X | X | X | 0C0000h to 0C7FFFh |
|  | SA32 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | X | X | X | 0C8000h to 0CFFFFh |
|  | SA33 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | X | X | X | 0D0000h to 0D7FFFh |
|  | SA34 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | X | X | X | 0D8000h to 0DFFFFh |
|  | SA35 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | X | X | X | 0E0000h to 0E7FFFh |
|  | SA36 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | X | X | X | 0E8000h to 0EFFFFh |
|  | SA37 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | X | X | X | 0F0000h to 0F7FFFh |
|  | SA38 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | X | X | X | 0F8000h to 0FFFFFh |
|  | SA39 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | X | X | X | 100000h to 107FFFh |
|  | SA40 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | X | X | X | 108000h to 10FFFFh |
|  | SA41 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | X | X | X | 110000h to 117FFFh |
|  | SA42 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | X | X | X | 118000h to 11FFFFh |
|  | SA43 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | X | X | X | 120000h to 127FFFh |
|  | SA44 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | X | X | X | 128000h to 12FFFFh |
|  | SA45 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | X | X | X | 130000h to 137FFFh |
|  | SA46 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | X | X | X | 138000h to 13FFFFh |
|  | SA47 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | X | X | X | 140000h to 147FFFh |
|  | SA48 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | X | X | X | 148000h to 14FFFFh |
|  | SA49 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | X | X | X | 150000h to 157FFFh |
|  | SA50 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | X | X | X | 158000h to 15FFFFh |
|  | SA51 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | X | X | X | 160000h to 167FFFh |
|  | SA52 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | X | X | X | 168000h to 16FFFFh |
|  | SA53 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | X | X | X | 170000h to 177FFFh |
|  | SA54 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | X | X | X | 178000h to 17FFFFh |
|  | SA55 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | X | X | X | 180000h to 187FFFh |
|  | SA56 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | X | X | X | 188000h to 18FFFFh |
|  | SA57 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | X | X | X | 190000h to 197FFFh |
|  | SA58 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | X | X | X | 198000h to 19FFFFh |
|  | SA59 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | X | X | X | 1A0000h to 1A7FFFh |
|  | SA60 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | X | X | X | 1A8000h to 1AFFFFh |
|  | SA61 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | X | X | X | 1B0000h to 1B7FFFh |
|  | SA62 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | X | X | X | 1B8000h to 1BFFFFh |
|  | SA63 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | X | X | X | 1C0000h to 1C7FFFh |
|  | SA64 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | X | X | X | 1C8000h to 1CFFFFh |
|  | SA65 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | X | X | X | 1D0000h to 1D7FFFh |
|  | SA66 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | X | X | X | 1D8000h to 1DFFFFh |
|  | SA67 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | X | X | X | 1E0000h to 1E7FFFh |
|  | SA68 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | X | X | X | 1E8000h to 1EFFFFh |
|  | SA69 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | X | X | X | 1F0000h to 1F7FFFh |
|  | SA70 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | X | X | X | 1F8000h to 1FFFFFh |

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| Bank | Sector | Sector Address |  |  |  |  |  |  |  |  |  | Address Range <br> Word Mode |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Bank Address |  |  |  |  |  |  |  |  |  |  |
|  |  | A 21 | A20 | $\mathrm{A}_{19}$ | $\mathrm{A}_{18}$ | $\mathrm{A}_{17}$ | $\mathrm{A}_{16}$ | $\mathrm{A}_{15}$ | A14 | $\mathrm{A}_{13}$ | $\mathrm{A}_{12}$ |  |
| Bank C | SA71 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | X | X | X | 200000h to 207FFFh |
|  | SA72 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | X | X | X | 208000h to 20FFFFh |
|  | SA73 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | X | X | X | 210000h to 217FFFh |
|  | SA74 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | X | X | X | 218000h to 21FFFFh |
|  | SA75 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | X | X | X | 220000h to 227FFFh |
|  | SA76 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | X | X | X | 228000h to 22FFFFh |
|  | SA77 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | X | X | X | 230000h to 237FFFh |
|  | SA78 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | X | X | X | 238000h to 23FFFFh |
|  | SA79 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | X | X | X | 240000h to 247FFFh |
|  | SA80 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | X | X | X | 248000h to 24FFFFh |
|  | SA81 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | X | X | X | 250000h to 257FFFh |
|  | SA82 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | X | X | X | 258000h to 25FFFFh |
|  | SA83 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | X | X | X | 260000h to 267FFFh |
|  | SA84 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | X | X | X | 268000h to 26FFFFh |
|  | SA85 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | X | X | X | 270000h to 277FFFh |
|  | SA86 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | X | X | X | 278000h to 27FFFFh |
|  | SA87 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | X | X | X | 280000h to 287FFFh |
|  | SA88 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | X | X | X | 288000h to 28FFFFh |
|  | SA89 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | X | X | X | 290000h to 297FFFh |
|  | SA90 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | X | X | X | 298000h to 29FFFFh |
|  | SA91 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | X | X | X | 2A0000h to 2A7FFFh |
|  | SA92 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | X | X | X | 2A8000h to 2AFFFFh |
|  | SA93 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | X | X | X | 2B0000h to 2B7FFFh |
|  | SA94 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | X | X | X | 2B8000h to 2BFFFFh |
|  | SA95 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | X | X | X | 2C0000h to 2C7FFFh |
|  | SA96 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | X | X | X | 2C8000h to 2CFFFFh |
|  | SA97 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | X | X | X | 2D0000h to 2D7FFFh |
|  | SA98 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | X | X | X | 2D8000h to 2DFFFFh |
|  | SA99 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | X | X | X | 2E0000h to 2E7FFFh |
|  | SA100 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | X | X | X | 2E8000h to 2EFFFFh |
|  | SA101 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | X | X | X | 2F0000h to 2F7FFFh |
|  | SA102 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | X | X | X | 2F8000h to 2FFFFFh |
|  | SA103 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | X | X | X | 300000h to 307FFFh |
|  | SA104 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | X | X | X | 308000h to 30FFFFh |
|  | SA105 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | X | X | X | 310000h to 317FFFh |
|  | SA106 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | X | X | X | 318000h to 31FFFFh |
|  | SA107 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | X | X | X | 320000h to 327FFFh |
|  | SA108 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | X | X | X | 328000h to 32FFFFh |
|  | SA109 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | X | X | X | 330000h to 337FFFh |
|  | SA110 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | X | X | X | 338000h to 33FFFFh |
|  | SA111 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | X | X | X | 340000h to 347FFFh |
|  | SA112 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | X | X | X | 348000h to 34FFFFh |
|  | SA113 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | X | X | X | 350000h to 357FFFh |
|  | SA114 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | X | X | X | 358000h to 35FFFFh |
|  | SA115 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | X | X | X | 360000h to 367FFFh |
|  | SA116 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | X | X | X | 368000h to 36FFFFh |
|  | SA117 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | X | X | X | 370000h to 377FFFh |
|  | SA118 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | X | X | X | 378000h to 37FFFFh |

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(Continued)

| Bank | Sector | Sector Address |  |  |  |  |  |  |  |  |  | Address Range <br> Word Mode |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Bank Address |  |  |  |  |  |  |  |  |  |  |
|  |  | A 21 | A20 | $\mathrm{A}_{19}$ | A18 | A17 | A16 | A15 | $\mathrm{A}_{14}$ | A13 | $\mathrm{A}_{12}$ |  |
| Bank D | SA119 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | X | X | X | 380000h to 387FFFh |
|  | SA120 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | X | X | X | 388000h to 38FFFFh |
|  | SA121 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | X | X | X | 390000h to 397FFFh |
|  | SA122 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | X | X | X | 398000h to 39FFFFh |
|  | SA123 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | X | X | X | 3A0000h to 3A7FFFh |
|  | SA124 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | X | X | X | 3A8000h to 3AFFFFh |
|  | SA125 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | X | X | X | 3B0000h to 3B7FFFh |
|  | SA126 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | X | X | X | 3B8000h to 3BFFFFh |
|  | SA127 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | X | X | X | 3C0000h to 3C7FFFh |
|  | SA128 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | X | X | X | 3C8000h to 3CFFFFh |
|  | SA129 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | X | X | X | 3D0000h to 3D7FFFh |
|  | SA130 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | X | X | X | 3D8000h to 3DFFFFh |
|  | SA131 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | X | X | X | 3E0000h to 3E7FFFh |
|  | SA132 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | X | X | X | 3E8000h to 3EFFFFh |
|  | SA133 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | X | X | X | 3F0000h to 3F7FFFh |
|  | SA134 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 3F8000h to 3F8FFFh |
|  | SA135 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 3F9000h to 3F9FFFh |
|  | SA136 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 3FA000h to 3FAFFFh |
|  | SA137 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 3FB000h to 3FBFFFh |
|  | SA138 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 3FC000h to 3FCFFFh |
|  | SA139 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 3FD000h to 3FDFFFh |
|  | SA140 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 3FE000h to 3FEFFFh |
|  | SA141 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 3FF000h to 3FFFFFh |

## - Sector Group Addresses

| Sector Group | $\mathrm{A}_{21}$ | $\mathrm{A}_{20}$ | $\mathrm{A}_{19}$ | A18 | A17 | $\mathrm{A}_{16}$ | $\mathrm{A}_{15}$ | $\mathrm{A}_{14}$ | $\mathrm{A}_{13}$ | $\mathrm{A}_{12}$ | Sectors |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SGA0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | SA0 |
| SGA1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | SA1 |
| SGA2 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | SA2 |
| SGA3 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | SA3 |
| SGA4 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | SA4 |
| SGA5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | SA5 |
| SGA6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | SA6 |
| SGA7 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | SA7 |
| SGA8 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | X | X | X | SA8 to SA10 |
|  |  |  |  |  |  | 1 |  |  |  |  |  |
|  |  |  |  |  |  | 1 | 1 |  |  |  |  |
| SGA9 | 0 | 0 | 0 | 0 | 1 | X | X | X | X | X | SA11 to SA14 |
| SGA10 | 0 | 0 | 0 | 1 | 0 | X | X | X | X | X | SA15 to SA18 |
| SGA11 | 0 | 0 | 0 | 1 | 1 | X | X | X | X | X | SA19 to SA22 |
| SGA12 | 0 | 0 | 1 | 0 | 0 | X | X | X | X | X | SA23 to SA26 |
| SGA13 | 0 | 0 | 1 | 0 | 1 | X | X | X | X | X | SA27 to SA30 |
| SGA14 | 0 | 0 | 1 | 1 | 0 | X | X | X | X | X | SA31 to SA34 |
| SGA15 | 0 | 0 | 1 | 1 | 1 | X | X | X | X | X | SA35 to SA38 |
| SGA16 | 0 | 1 | 0 | 0 | 0 | X | X | X | X | X | SA39 to SA42 |
| SGA17 | 0 | 1 | 0 | 0 | 1 | X | X | X | X | X | SA43 to SA46 |
| SGA18 | 0 | 1 | 0 | 1 | 0 | X | X | X | X | X | SA47 to SA50 |
| SGA19 | 0 | 1 | 0 | 1 | 1 | X | X | X | X | X | SA51 to SA54 |
| SGA20 | 0 | 1 | 1 | 0 | 0 | X | X | X | X | X | SA55 to SA58 |
| SGA21 | 0 | 1 | 1 | 0 | 1 | X | X | X | X | X | SA59 to SA62 |
| SGA22 | 0 | 1 | 1 | 1 | 0 | X | X | X | X | X | SA63 to SA66 |
| SGA23 | 0 | 1 | 1 | 1 | 1 | X | X | X | X | X | SA67 to SA70 |
| SGA24 | 1 | 0 | 0 | 0 | 0 | X | X | X | X | X | SA71 to SA74 |
| SGA25 | 1 | 0 | 0 | 0 | 1 | X | X | X | X | X | SA75 to SA78 |
| SGA26 | 1 | 0 | 0 | 1 | 0 | X | X | X | X | X | SA79 to SA82 |
| SGA27 | 1 | 0 | 0 | 1 | 1 | X | X | X | X | X | SA83 to SA86 |
| SGA28 | 1 | 0 | 1 | 0 | 0 | X | X | X | X | X | SA87 to SA90 |
| SGA29 | 1 | 0 | 1 | 0 | 1 | X | X | X | X | X | SA91 to SA94 |
| SGA30 | 1 | 0 | 1 | 1 | 0 | X | X | X | X | X | SA95 to SA98 |
| SGA31 | 1 | 0 | 1 | 1 | 1 | X | X | X | X | X | SA99 to SA102 |
| SGA32 | 1 | 1 | 0 | 0 | 0 | X | X | X | X | X | SA103 to SA106 |
| SGA33 | 1 | 1 | 0 | 0 | 1 | X | X | X | X | X | SA107 to SA110 |
| SGA34 | 1 | 1 | 0 | 1 | 0 | X | X | X | X | X | SA111 to SA114 |
| SGA35 | 1 | 1 | 0 | 1 | 1 | X | X | X | X | X | SA115 to SA118 |
| SGA36 | 1 | 1 | 1 | 0 | 0 | X | X | X | X | X | SA119 to SA122 |
| SGA37 | 1 | 1 | 1 | 0 | 1 | X | X | X | X | X | SA123 to SA126 |
| SGA38 | 1 | 1 | 1 | 1 | 0 | X | X | X | X | X | SA127 to SA130 |
|  |  |  |  |  |  | 0 | 0 |  |  |  |  |
| SGA39 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | X | X | X | SA131 to SA133 |
|  |  |  |  |  |  | 1 | 0 |  |  |  |  |
| SGA40 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | SA134 |
| SGA41 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | SA135 |
| SGA42 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | SA136 |
| SGA43 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | SA137 |
| SGA44 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | SA138 |
| SGA45 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | SA139 |
| SGA46 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | SA140 |
| SGA47 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | SA141 |

## MB84VP23481FK-70

- Flash Memory Autoselect Codes

| Type | $\mathrm{A}_{21}$ to $\mathrm{A}_{12}$ | A6 | A5 | A4 | A3 | $\mathrm{A}_{2}$ | $\mathrm{A}_{1}$ | A0 | Code (HEX) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Manufacture's Code | BA | VIL | X | X | VIL | VIL | VIL | VIL | 04h |
| Device Code | BA | VIL | x | X | VIL | VIL | VIL | $\mathrm{V}_{\mathrm{H}}$ | 227Eh |
| Extended Device Code*2 | BA | VIL | X | X | $\mathrm{V}_{1}$ | $\mathrm{V}_{1}$ | $\mathrm{V}_{1}$ | VIL | 2215h |
|  | BA | VIL | x | X | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{1+}$ | $\mathrm{V}_{1}$ | 2201h |
| Sector Group Protection* ${ }^{*}$ | Sector <br> Group <br> Addresses | VIL | VIH | VIH | VIH | VIL | VIH | VIL | 01h* ${ }^{1}$ |

*1:Sector Group can be protected by "Sector Group Protection", "Extended Sector Group Protection" and "New Sector Protection (PPB Protection)".
Outputs 01 h at protected sector group addresses and outputs 00 h at unprotected sector group addresses.
*2:A read cycle at address (BA) 01h outputs device code. When 227Eh is output, it indicates that two additional codes, called Extended Device Codes, will be required. Therefore the system may continue reading out these Extended Device Codes at the address of (BA) OEh, as well as at (BA) OFh

- Flash Memory Command Definitions

| Command Sequence | Bus Write Cycles Req'd | First Bus Write Cycle |  | SecondBusWrite Cycle |  | Third Bus Write Cycle |  | Fourth Bus Read/Write Cycle |  | Fifth Bus Write Cycle |  | Sixth Bus Write Cycle |  | Seventh Bus Write Cycle |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data |
| Read/Reset *1 | 2 | XXXh | F0h | RA | RD | - | - | - | - | - | - | - | - | - | - |
| Read/Reset*1 | 4 | 555h | AAh | 2AAh | 55h | 555h | FOh | RA | RD | - | - | - | - | - | - |
| Autoselect | 3 | 555h | AAh | 2AAh | 55h | $\begin{aligned} & (\mathrm{BA}) \\ & 555 \mathrm{~h} \end{aligned}$ | 90h | - | - | - | - | - | - | - | - |
| Program | 4 | 555h | AAh | 2AAh | 55h | 555h | AOh | PA | PD | - | - | - | - | - | - |
| Chip Erase | 6 | 555h | AAh | 2AAh | 55h | 555h | 80h | 555h | AAh | 2AAh | 55h | 555h | 10h | - | - |
| Sector Erase | 6 | 555h | AAh | 2AAh | 55h | 555h | 80h | 555h | AAh | 2AAh | 55h | SA | 30h | - | - |
| Program/Erase Suspend | 1 | BA | B0h | - | - | - | - | - | - | - | - | - | - | - | - |
| Program/Erase Resume | 1 | BA | 30h | - | - | - | - | - | - | - | - | - | - | - | - |
| Set to Fast Mode | 3 | 555h | AAh | 2AAh | 55h | 555h | 20h | - | - | - | - | - | - | - | - |
| Fast Program *2 | 2 | XXXh | AOh | PA | PD | - | - | - | - | - | - | - | - | - | - |
| Reset from Fast Mode *2 | 2 | BA | 90h | XXXh | FOh* ${ }^{* 6}$ | - | - | - | - | - | - | - | - | - | - |
| Extended Sector Group Protection*3 | 4 | XXXh | 60h | SGA | 60h | SGA | 40h | SGA | SD | - | - | - | - | - | - |
| Query *4 | 1 | $\begin{aligned} & (\mathrm{BA}) \\ & 55 \mathrm{~h} \end{aligned}$ | 98h | - | - | - | - | - | - | - | - | - | - | - | - |
| HiddenROM Entry | 3 | 555h | AAh | 2AAh | 55h | 555h | 88h | - | - | - | - | - | - | - | - |
| HiddenROM Program *5 | 4 | 555h | AAh | 2AAh | 55h | 555h | A0h | $\begin{gathered} (\mathrm{HRA}) \\ \mathrm{PA} \end{gathered}$ | PD | - | - | - | - | - | - |
| HiddenROM Exit *5 | 4 | 555h | AAh | 2AAh | 55h | $\begin{aligned} & \text { (HRBA) } \\ & 555 h \end{aligned}$ | 90h | XXXh | 00h | - | - | - | - | - | - |
| HiddenROM Protect *5 | 6 | 555h | AAh | 2AAh | 55h | 555h | 60h | OPBP | 68h | OPBP | 48h | XXXh | RD (0) | - | - |
|  |  |  |  |  |  |  |  | XXOh | PD0 | - | - | - | - | - | - |
| ssword | 4 |  |  |  |  |  |  | XX1h | PD1 | - | - | - | - | - | - |
| Pr |  |  |  |  |  |  |  | XX2h | PD2 | - | - | - | - | - | - |
|  |  |  |  |  |  |  |  | XX3h | PD3 | - | - | - | - | - | - |
| Password Unlock | 7 | 555h | AAh | 2AAh | 55h | 555h | 28h | XXOh | PDO | XX1h | PD1 | XX2h | PD2 | XX3h | PD3 |
| Password Verify | 4 | 555h | AAh | 2AAh | 55h | 555h | C8h | PWA | PWD | - | - | - | - | - | - |

(Continued)

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(Continued)

| Command Sequence | Bus Write Cycles Req'd | First Bus Write Cycle |  | Second Bus Write Cycle |  | Third Bus Write Cycle |  | Fourth Bus Read/Write Cycle |  | Fifth Bus Write Cycle |  | Sixth Bus Write Cycle |  | Seventh Bus Write Cycle |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data |
| Password Mode Locking Bit Program | 6 | 555h | AAh | 2AAh | 55h | 555h | 60h | PL | 68h | PL | 48h | XXh | RD(0) | - | - |
| Persistent Protection Mode Locking Bit Program | 6 | 555h | AAh | 2AAh | 55h | 555h | 60h | SPML | 68h | SPML | 48h | XXh | RD(0) | - | - |
| PPB Program | 6 | 555h | AAh | 2AAh | 55h | 555h | 60h | SA+WP | 68h | SA+WP | 48h | XXh | $\mathrm{RD}(0)$ | - | - |
| PPB Verify | 4 | 555h | AAh | 2AAh | 55h | 555h | 90h | SA+x02 | RD(0) | - | - | - | - | - | - |
| All PPB Erase *8 | 6 | 555h | AAh | 2AAh | 55h | 555h | 60h | SA+WP | 60h | SA+WP | 40h | XXh | RD(0) | - | - |
| PPB Lock Bit Set | 3 | 555h | AAh | 2AAh | 55h | 555h | 78h | - | - | - | - | - | - | - | - |
| PPB Lock Bit Verify | 4 | 555h | AAh | 2AAh | 55h | 555h | 58h | SA | $\mathrm{RD}(1)$ | - | - | - | - | - | - |
| DPB Write | 4 | 555h | AAh | 2AAh | 55h | 555h | 48h | SA | X1h | - | - | - | - | - | - |
| DPB Erase | 4 | 555h | AAh | 2AAh | 55h | 555h | 48h | SA | X0h | - | - | - | - | - | - |
| DPB Verify | 4 | 555h | AAh | 2AAh | 55h | 555h | 58h | SA | RD(0) | - | - | - | - | - | - |

## Legend:

RA = Address of the memory location to be read
PA = Address of the memory location to be programmed
Addresses are latched on the falling edge of the write pulse.
SA = Address of the sector
BA = Bank Address
$\mathrm{RD}=$ Data read from location RA during read operation.
PD = Data to be programmed at location PA. Data is latched on the rising edge of write pulse.
SGA $=$ Sector group address to be protected. Set sector group address and ( $\left.A_{6}, A_{5}, A_{4}, A_{3}, A_{2}, A_{1}, A_{0}\right)$
$=(0,1,1,1,0,1,0)$
SD = Sector group protection verify data. Output 01h at protected sector group addresses and output 00 h at unprotected sector group addresses.
HRA = Address of the HiddenROM area (000000h to 00007Fh)
HRBA $=$ Bank Address of the HiddenROM area ( $\mathrm{A}_{21}=\mathrm{A}_{20}=\mathrm{A}_{19}=\mathrm{V}_{11}$ )
$R D(0)=D Q_{0}$ data, $R D(1)=D Q_{1}$ data. PPB Lock bit is read on $D_{1}$ and PPB or DPB are read on DQo. If set, $\mathrm{DQ}_{0} / \mathrm{DQ}_{1}=1$. If cleared, $\mathrm{DQ}_{0} / \mathrm{DQ}_{1}=0$.
OPBP $=\left(A_{6}, A_{5}, A_{4}, A_{3}, A_{2}, A_{1}, A_{0}\right)$ is $(X, 0,1,1,0,1,0)$
SLA = Address of the sector to be locked. Set sector address (SA) and either $A_{6}=1$ for unlocked or $A_{6}=0$ for locked
PWA/PWD = Password Address/Password Data
$P L=\quad\left(A_{6}, A_{5}, A_{4}, A_{3}, A_{2}, A_{1}, A_{0}\right)$ is $(X, 0,0,1,0,1,0)$
SPML $=\left(A_{6}, A_{5}, A_{4}, A_{3}, A_{2}, A_{1}, A_{0}\right)$ is $(X, 0,1,0,0,1,0)$
$W P=\left(A_{6}, A_{5}, A_{4}, A_{3}, A_{2}, A_{1}, A_{0}\right)$ is $(X, 1,1,1,0,1,0)$

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*1: Both of these reset commands are equivalent.
*2: This command is valid during Fast Mode.
*3: This command is valid while $\overline{\operatorname{RESET}}=\mathrm{V}_{\mathrm{I}}$.
*4: The valid addresses are $\mathrm{A}_{6}$ to $\mathrm{A}_{0}$.
*5: This command is valid during HiddenROM mode.
*6: The data "00h" is also acceptable.
*7: Data before fourth cycle also need to be programmed repearting from first cycle to third cycle.
*8: $\mathrm{RD}(0)$ of the sixth cycle shows PPB erase status. When $\mathrm{RD}(0)$ is " 1 ", programming must be repeated from the beginning of first cycle to the fourth cycle; both fifth and the sixth validate full completion of erase.

Notes : • Address bits $\mathrm{A}_{21}$ to $\mathrm{A}_{11}=\mathrm{X}=$ " H " or " L " for all address commands except for PA, SA, BA, SGA, OPBP, SLA, PWA, PL, SPML, WP.

- Bus operations are defined in "■ DEVICE BUS OPERATIONS".
- The system should generate the following address patterns:

555 h or 2AAh to addresses $\mathrm{A}_{10}$ to $\mathrm{A}_{0}$

- Both Read/Reset commands are functionally equivalent, resetting the device to the read mode.
- Command combinations not described in Command Definitions table are illegal.


## MB84VP23481FK-70

2. AC Characteristics

- Read Only Operations Characteristics

| Parameter | Symbol |  | Condition | Value* |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | JEDEC | Standard |  | Min | Max |  |
| Read Cycle Time | tavav | trc | - | 65 | - | ns |
| Address to Output Delay | tavav | tacc | $\begin{aligned} & \overline{\mathrm{CE}} \mathrm{f}=\mathrm{V}_{\mathrm{LI}} \\ & \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IL}} \end{aligned}$ | - | 65 | ns |
| Page Read Cycle Time | - | tprc | - | 25 | - | ns |
| Page Address to Output Delay | - | tpacc | $\begin{aligned} & \overline{\mathrm{CE}} \mathrm{f}=\mathrm{V}_{\mathrm{LL}} \\ & \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IL}} \end{aligned}$ | - | 25 | ns |
| Chip Enable to Output Delay | telav | tce | $\overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IL}}$ | - | 65 | ns |
| Output Enable to Output Delay | tglov | toe | - | - | 25 | ns |
| Chip Enable to Output High-Z | tehaz | tof | - | - | 25 | ns |
| Output Enable to Output High-Z | tghaz | tof | - | - | 25 | ns |
| Output Hold Time From Address, CEf or OE, <br> Whichever Occurs First | taxax | tor | - | 4 | - | ns |
| RESET Pin Low to Read Mode | - | tready | - | - | 20 | ns |

* : Test Conditions: Output Load: $\mathrm{V}_{\mathrm{ccf}}=2.7 \mathrm{~V}$ to $3.1 \mathrm{~V}: 1 \mathrm{TTL}$ gate and 30 pF

Input rise and fall times: 5 ns
Input pulse levels: 0.0 V to $\mathrm{V}_{\text {ccf }}$
Timing measurement reference level
Input: $0.5 \times \mathrm{Vccf}$
Output: $0.5 \times V_{\text {ccf }}$

- Write (Erase/Program) Operations

| Parameter |  | Symbol |  | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | JEDEC | Standard | Min | Typ | Max |  |
| Write Cycle Time |  | tavav | two | 65 | - | - | ns |
| Address Setup Time |  | tavwL | tas | 0 | - | - | ns |
| Address Setup Time to $\overline{\mathrm{OE}}$ Low During Toggle Bit Polling |  | - | taso | 12 | - | - | ns |
| Address Hold Time |  | twlax | taH | 45 | - | - | ns |
| Address Hold Time from $\overline{\mathrm{CE}} f$ or $\overline{\mathrm{OE}}$ High During Toggle Bit Polling |  | - | taht | 0 | - | - | ns |
| Data Setup Time |  | tovwh | tos | 35 | - | - | ns |
| Data Hold Time |  | twhox | toh | 0 | - | - | ns |
| Output Enable Hold Time | Read | - | toer | 0 | - | - | ns |
|  | Toggle and Data Polling |  |  | 10 | - | - | ns |
| $\overline{\text { CE High During Toggle Bit Polling }}$ |  | - | tceph | 20 | - | - | ns |
| $\overline{\text { OE High During Toggle Bit Polling }}$ |  | - | toEph | 20 | - | - | ns |
| Read Recover Time Before Write |  | tarwL | tarwL | 0 | - | - | ns |
| Read Recover Time Before Write |  | tghel | tGHEL | 0 | - | - | ns |
| $\overline{\text { CE Setup Time }}$ |  | tELwL | tcs | 0 | - | - | ns |
| $\overline{\text { WE Setup Time }}$ |  | twleL | tws | 0 | - | - | ns |
| $\overline{\text { CE Hold Time }}$ |  | twhen | tch | 0 | - | - | ns |
| $\overline{\text { WE Hold Time }}$ |  | tehwh | twh | 0 | - | - | ns |
| Write Pulse Width |  | twLwH | twp | 35 | - | - | ns |
| $\overline{\text { CE Pulse Width }}$ |  | teLeH | tcp | 35 | - | - | ns |
| Write Pulse Width High |  | twhwL | twPH | 30 | - | - | ns |
| $\overline{\text { CE Pulse Width High }}$ |  | tehel | tcPH | 30 | - | - | ns |
| Word Programming Operation |  | twewhi | twHwH1 | - | 6 | - | $\mu \mathrm{s}$ |
| Sector Erase Operation*1 |  | twHwh2 | twhwhz | - | 0.5 | - | s |
| $\mathrm{V}_{c c}$ Setup Time |  | - | tvcs | 50 | - | - | $\mu \mathrm{s}$ |
| Rise Time to $\mathrm{V}_{\text {ACC }}{ }^{* 2}$ |  | - | tvaccr | 500 | - | - | ns |

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(Continued)

| Parameter | Symbol |  | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | JEDEC | Standard | Min | Typ | Max |  |
| Recover Time from RY/ $\overline{\mathrm{BY}}$ | - | trb | 0 | - | - | ns |
| RESET Pulse Width | - | $t_{\text {RP }}$ | 500 | - | - | ns |
| $\overline{\text { RESET High Level Period Before Read }}$ | - | trH | 200 | - | - | ns |
| Program/Erase Valid to RY/ $\overline{\mathrm{BY}}$ Delay | - | trusy | - | - | 90 | ns |
| Delay Time from Embedded Output Enable | - | teoe | - | - | 65 | ns |
| Erase Time-out Time | - | trow | 50 | - | - | ns |
| Erase Suspend Transition Time | - | tspD | - | - | 20 | ns |

*1 : This does not include the preprogramming time.
*2 : This timing is for Accelerated Program operation.

## MB84VP23481FK-70

## - Read Operation Timing Diagram



## MB84VP23481FK-70

- Page Read Operation Timing Diagram



## MB84VP23481FK-70

- Hardware Reset/Read Operation Timing Diagram



## MB84VP23481FK-70

- Alternate $\overline{\text { WE Controlled Program Operation Timing Diagram }}$


Notes : • PA is address of the memory location to be programmed.

- PD is data to be programmed at word address.
- $\overline{\mathrm{DQ}}_{7}$ is the output of the complement of the data written to the device.
- Dout is the output of the data written to the device.
- Figure indicates last two bus cycles out of four bus cycle sequence.


## MB84VP23481FK-70

- Alternate $\overline{\text { CE }}$ Controlled Program Operation Timing Diagram


Notes : • PA is address of the memory location to be programmed.

- PD is data to be programmed at word address.
- $\overline{\mathrm{DQ}}_{7}$ is the output of the complement of the data written to the device.
- Dout is the output of the data written to the device.
- Figure indicates last two bus cycles out of four bus cycle sequence.


## MB84VP23481FK-70

- Chip/Sector Erase Operation Timing Diagram

* $: S A$ is the sector address for Sector Erase.


## MB84VP23481FK-70

## - Data Polling during Embedded Algorithm Operation Timing Diagram



## MB84VP23481FK-70

- AC Waveforms for Toggle Bit I during Embedded Algorithm Operations

*: DQ6 stops toggling (The device has completed the Embedded operation).


## MB84VP23481FK-70

## - Bank-to-Bank Read/Write Timing Diagram



## MB84VP23481FK-70

- DQ ${ }_{2}$ vs. DQ6

- RY/ $\overline{\mathrm{BY}}$ Timing Diagram during Program/Erase Operation Timing Diagram
$\overline{\mathrm{CEf}}$


## MB84VP23481FK-70

- $\overline{\operatorname{RESET}}, \mathrm{RY} / \overline{\mathrm{BY}}$ Timing Diagram



## MB84VP23481FK-70

- Temporary Sector Group Unprotection Timing Diagram



## MB84VP23481FK-70

## - Extended Sector Group Protection Timing Diagram



SGAX : Sector Group Address to be protected
SGAY : Next Sector Group Address to be protected
TIME-OUT : Time-Out window $=250 \mu \mathrm{~s}(\mathrm{Min})$

## MB84VP23481FK-70

- Accelerated Program Timing Diagram



## MB84VP23481FK-70

## 3. Erase and Programming Performance

| Parameter | Limits |  |  | Unit | Comments |
| :--- | :---: | :---: | :---: | :---: | :--- |
|  | Min | Typ | Max |  | 2.0 |
| s | Excludes programming time <br> prior to erasure |  |  |  |
| Sector Erase Time | - | 0.5 | 100 | $\mu \mathrm{~s}$ | Excludes system-level <br> overhead |
| Word Programming Time | - | 6 | s | Excludes system-level <br> overhead |  |
| Chip Programming Time | - | 25.2 | 95 | - |  |
| Erase/Program Cycle | 100,000 | - | - | cycle |  |

Note Typical Erase conditions $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{c \mathrm{cf}}=2.9 \mathrm{~V}$
Typical Program conditions $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}$ ccf $=2.9 \mathrm{~V}$, Data $=$ Checker

## MB84VP23481FK-70

## 32 M FCRAM CHARACTERISTICS for MCP

## 1. Power Down (32M Page Mode FCRAM)

- Power Down (32M Page mode FCRAM)

The Power Down is to enter low power idle state when CE2r stays Low.
The 32M page mode FCRAM has four power down mode, Sleep, 4M Partial, 8M Partial, and 16M Partial. These can be programmed by series of read/write operation. Each mode has following features.

| Mode | Data Retention | Retention Address |
| :---: | :---: | :---: |
| Sleep (default) | No | N/A |
| 4 M Partial | 4 M bit | 00000 h to $3 F F F F h$ |
| 8 M Partial | 8 M bit | 00000 h to $7 F F F F \mathrm{~h}$ |
| 16 M Partial | 16 M bit | 00000 h to FFFFFh |

The default state is Sleep and it is the lowest power consumption but all data will be lost once CE2r is brought to Low for Power Down. It is not required to program to Sleep mode after power-up.

## - Power Down Program Sequence (32M Page mode FCRAM)

The program requires total 6 read/write operation with unique address and data. Between each read/write operation requires that device be in standby mode. Following table shows the detail sequence.

| Cycle \# | Operation | Address | Data |
| :---: | :---: | :---: | :---: |
| 1st | Read | 1FFFFFh (MSB) | Read Data (RDa) |
| 2nd | Write | 1FFFFFh | RDa |
| 3rd | Write | 1FFFFFh | RDa |
| 4th | Write | 1FFFFFh | 0000h |
| 5th | Write | 1FFFFFh | Data Key |
| 6th | Read | Address Key | Read Data (RDb) |

The first cycle is to read from most significant address (MSB).
The second and third cycle are to write back the data (RDa) read by first cycle. If the third cycle is written into the different address, the program is cancelled and the data written by the second or third cycle is valid as a normal write operation.
The forth and fifth cycle is to write the data key for program. The data of forth cycle must be all 0's and data of fifth cycle is a data key for mode selection. If the forth cycle is written into different address, the program is also cancelled.
The last cycle is to read from specific address key for mode selection. The both data key written by fifth cycle and address key must be the same mode for proper programming.
Once this program sequence is performed from a Partial mode to other Partial mode, the write data may be lost. So, it should perform this program prior to regular read/write operation if Partial mode is used.

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## - Address Key (32M Page mode FCRAM)

The address key has following format.

| Mode | Address |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | $\mathbf{A}_{20}$ | $\mathbf{A}_{19}$ | $\mathbf{A}_{18}$ to $\mathbf{A}_{0}$ | Binary |
| Sleep (default) | 1 | 1 | 1 | 1 FFFFFh |
| 4M Partial | 0 | 1 | 1 | 0FFFFFh |
| 8M Partial | 1 | 0 | 1 | 17FFFFh |
| 16M Partial | 0 | 0 | 1 | $07 F F F F h$ |

## - Data Key (32M Page mode FCRAM)

The data key has following format.

| Mode | Data |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | $\mathbf{D Q}_{15}$ to $\mathbf{D Q}_{\mathbf{8}}$ | $\mathbf{D Q}_{\mathbf{7}}$ to $\mathbf{D Q}_{\mathbf{2}}$ | $\mathbf{D Q}_{\mathbf{1}}$ | $\mathbf{D Q}_{\mathbf{0}}$ |
| Sleep (default) | 0 | 0 | 1 | 1 |
| 4M Partial | 0 | 0 | 1 | 0 |
| 8M Partial | 0 | 0 | 0 | 1 |
| 16M Partial | 0 | 0 | 0 | 0 |

The upper byte of data code may be ignored and it is just for recommendation to write 0's to upper byte for future compatibility.

## MB84VP23481FK-70

## 2. AC Characteristics

- READ OPERATION (32M Page mode FCRAM)

| Parameter | Symbol | Value |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |
| Read Cycle Time | trc | 70 | 1000 | ns | *1, *2 |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ Access Time | tce | - | 70 | ns | *3 |
| $\overline{\text { OE Access Time }}$ | toe | - | 40 | ns | *3 |
| Address Access Time | $\mathrm{t}_{\text {A }}$ | - | 70 | ns | *3, *5 |
| $\overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ Access Time | tBA | - | 30 | ns | *3 |
| Page Address Access Time | tpaA | - | 18 | ns | *3, *6 |
| Page Read Cycle Time | tprc | 25 | 1000 | ns | *1, *6, *7 |
| Output Data Hold Time | tor | 5 | - | ns | *3 |
| $\overline{\mathrm{CE}} 1 \mathrm{l}$ Low to Output Low-Z | tclz | 3 | - | ns | *4 |
| $\overline{\mathrm{OE}}$ Low to Output Low-Z | tolz | 0 | - | ns | *4 |
| $\overline{\mathrm{LB}} / \overline{\text { UB }}$ Low to Output Low-Z | tblz | 0 | - | ns | *4 |
| $\overline{\mathrm{CE}} 1 r$ High to Output High-Z | tchz | - | 20 | ns | *4 |
| $\overline{\text { OE High to Output High-Z }}$ | tohz | - | 20 | ns | *4 |
| $\overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ High to Output High-Z | tbhz | - | 20 | ns | *4 |
| Address Setup Time to $\overline{\mathrm{CE}} 1 \mathrm{r}$ Low | tasc | -5 | - | ns |  |
| Address Setup Time to $\overline{\mathrm{OE}}$ Low | taso | 10 | - | ns |  |
| Address Invalid Time | tax | - | 10 | ns | *5, *8 |
| Page Address Invalid Time | taxp | - | 10 | ns | *6, *8 |
| Address Hold Time from $\overline{\mathrm{CE}} 1 \mathrm{r}$ High | tснан | -5 | - | ns | *9 |
| Address Hold Time from $\overline{\mathrm{OE}}$ High | Тонан | -5 | - | ns |  |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High Pulse Width | tcp | 15 | - | ns |  |

*1 : Maximum value is applicable if $\overline{\mathrm{CE}} 1 \mathrm{r}$ is kept at Low without change of address input of $\mathrm{A}_{20}$ to $\mathrm{A}_{3}$.
If needed by system operation, please contact local FUJITSU representative for the relaxation of $1 \mu$ s limitation.
*2 : Address should not be changed within minimum trc.
*3 : The output load 30 pF .
*4 : The output load 5 pF without any other load.
*5 : Applicable to $\mathrm{A}_{20}$ to $\mathrm{A}_{3}$ when $\overline{\mathrm{CE}} 1 \mathrm{r}$ is kept at Low.
*6 : Applicable only to $A_{2}, A_{1}$ and $A_{0}$ when $\overline{C E} 1 r$ is kept at Low for the page address access.
*7 : In case Page Read Cycle is continued with keeping $\overline{\mathrm{CE}} 1 \mathrm{r}$ stays Low, $\overline{\mathrm{CE}} 1 \mathrm{r}$ must be brought to High within $4 \mu \mathrm{~s}$. In other words, Page Read Cycle must be closed within $4 \mu \mathrm{~s}$.
*8 : Applicable when at least two of address inputs among applicable are switched from previous state.
*9 : trc(Min) and tprc(Min) must be satisfied.

- WRITE OPERATION (32M Page mode FCRAM)

| Parameter | Symbol | Value |  | Unit | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |
| Write Cycle Time | twc | 70 | 1000 | ns | *1, *2 |
| Address Setup Time | $\mathrm{t}_{\text {AS }}$ | 0 | - | ns | *2 |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ Write Pulse Width | tcw | 45 | - | ns | *3 |
| $\overline{\text { WE Write Pulse Width }}$ | twp | 45 | - | ns | *3 |
| $\overline{\overline{L B}} / \overline{\text { UB }}$ Write Pulse Width | tsw | 45 | - | ns | *3 |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ Write Recovery Time | twrc | 15 | - | ns | *4 |
| $\overline{\text { WE Write Recovery Time }}$ | twr | 15 | 1000 | ns | *4 |
| $\overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ Write Recovery Time | tBR | 15 | 1000 | ns | *4 |
| Data Setup Time | tos | 20 | - | ns |  |
| Data Hold Time | toh | 0 | - | ns |  |
| Address Invalid Time after Write | taxw | - | 10 | ns | *5 |
| $\overline{\mathrm{OE}}$ High to $\overline{\mathrm{CE}} 1 r$ Low Setup Time for Write | tohcL | -5 | - | ns | *6 |
| OE High to Address Setup Time for Write | toes | 0 | - | ns | *7 |
| $\overline{\mathrm{LB}}$ and $\overline{\mathrm{UB}}$ Write Pulse Overlap | tswo | 20 | - | ns |  |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High Pulse Width | tcp | 15 | - | ns |  |

*1 : Maximum value is applicable if CE1r is kept at Low without any address change. If the relaxation is needed by system operation, please contact local FUJITSU representative for the relaxation of $1 \mu \mathrm{~s}$ limitation.
*2 : Minimum value must be equal or greater than the sum of write pulse (tcw, twp or tew) and write recovery time (twre, twr or tbr).
*3 : Write pulse is defined from High to Low transition of $\overline{C E} 1 r, \overline{W E}$, or $\overline{\mathrm{LB}} / \overline{\mathrm{UB}}$, whichever occurs last.
*4 : Write recovery is defined from Low to High transition of $\overline{\mathrm{CE}} 1 r$, $\overline{\mathrm{WE}}$, or $\overline{\mathrm{LB}} / \overline{\mathrm{UB}}$, whichever occurs first.
*5 : Applicable to any address change when $\overline{\mathrm{CE}} 1 \mathrm{r}$ stays Low.
*6 : If $\overline{\mathrm{OE}}$ is Low after minimum tohcL, read cycle is initiated. In other word, $\overline{\mathrm{OE}}$ must be brought to High within 5 ns after $\overline{\mathrm{CE}} 1 \mathrm{r}$ is brought to Low. Once read cycle is initiated, new write pulse should be input after minimum trc is met.
*7 : If $\overline{O E}$ is Low after new address input, read cycle is initiated. In other word, $\overline{\mathrm{OE}}$ must be brought to High at the same time or before new address valid. Once read cycle is initiated, new write pulse should be input after minimum tre is met.

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## - POWER DOWN PARAMETERS (32M Page mode FCRAM)

| Parameter | Symbol | Value |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |
| CE2r Low Setup Time for Power Down Entry | tcsp | 10 | - | ns |  |
| CE2r Low Hold Time after Power Down Entry | tc2LP | 70 | - | ns |  |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High Hold Time following CE2r High after Power Down Exit [SLEEP mode only] | tснн | 300 | - | $\mu \mathrm{s}$ | *1 |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High Hold Time following CE2r High after Power Down Exit [not in SLEEP mode] | tсннр | 1 | - | $\mu \mathrm{S}$ | *2 |
| CE1r High Setup Time following CE2r High after Power Down Exit | tchs | 0 | - | ns |  |

*1 : Applicable also to power-up.
*2 : Applicable when 4M, 8M, and 16M Partial mode is programmed.

- OTHER TIMING PARAMETERS (32M Page mode FCRAM)

| Parameter | Symbol | Value |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |
| $\overline{\mathrm{CE}}$ 1r High to $\overline{\mathrm{OE}}$ Invalid Time for Standby Entry | tснох | 10 | - | ns |  |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High to WE Invalid Time for Standby Entry | tchwx | 10 | - | ns | *1 |
| $\overline{\mathrm{CE}} 1 \mathrm{r}$ High Hold Time following CE2r High after Power-up | tснн | 300 | - | $\mu \mathrm{s}$ |  |
| Input Transition Time | t ${ }^{\text {t }}$ | 1 | 25 | ns | *2 |

*1 : Some data might be written into any address location if tcrwx(Min) is not satisfied.
*2 : The Input Transition Time ( t ) at AC testing is 5 ns as shown in below. If actual tt is longer than 5 ns , it may violate AC specification of some timing parameters.

- AC TEST CONDITIONS (32M Page mode FCRAM)

| Description | Symbol | Test Setup | Value | Unit | Remarks |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Input High Level | $\mathrm{V}_{\mathrm{H}}$ | - | $\mathrm{V}_{\mathrm{Ccr}}$ | V |  |
| Input Low Level | $\mathrm{V}_{\mathrm{IL}}$ | - | $\mathrm{V}_{\mathrm{ss}}$ | V |  |
| Input Timing Measurement Level | $\mathrm{V}_{\text {REF }}$ | - | $\mathrm{V}_{\mathrm{ccr}} \times 0.5$ | V |  |
| Input Transition Time | $\mathrm{t}_{\mathrm{T}}$ | Between $\mathrm{V}_{\mathrm{IL}}$ and $\mathrm{V}_{\mathrm{HH}}$ | 5 | ns |  |

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## - READ Timing \#1 (Basic Timing) (32M Page FCRAM)



Note : CE2r and $\overline{\text { WE }}$ must be High for entire read cycle.

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## - READ Timing \#2 ( $\overline{\mathrm{OE}}$ \& Address Access) (32M Page FCRAM)



Note: CE2r and WE must be High for entire read cycle.

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## - READ Timing \#3 ( $\overline{L B} / \overline{\text { UB }}$ Byte Access) (32M Page FCRAM)



Note : CE2r and $\overline{W E}$ must be High for entire read cycle.

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- READ Timing \#4 (Page Address Access after $\overline{\text { CE1r Control Access) (32M Page FCRAM) }}$


Note: CE2r, and $\overline{W E}$ must be High for entire read cycle.

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## - READ Timing \#5 (Random and Page Address Access) (32M Page FCRAM)



Note: CE2r, and $\overline{W E}$ must be High for entire read cycle.
Either or both $\overline{\mathrm{LB}}$ and $\overline{\mathrm{UB}}$ must be Low when both $\overline{\mathrm{CE}} 1 \mathrm{r}$ and $\overline{\mathrm{OE}}$ are Low.

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## - WRITE Timing \#1 (Basic Timing) (32M Page FCRAM)



Note : CE2r must be High for write cycle.

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## - WRITE Timing \#2 (WE Control) (32M Page FCRAM)



Note : CE2r must be High for write cycle.

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- WRITE Timing \#3-1 ( $\overline{\mathrm{WE}} / \overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ Byte Write Control) (32M Page FCRAM)


Note : CE2r must be High for write cycle.

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## - WRITE Timing \#3-2 ( $\overline{\mathrm{WE}} / \overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ Byte Write Control) (32M Page FCRAM)



Note : CE2r must be High for write cycle.

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- WRITE Timing \#3-3 ( $\overline{\mathrm{WE}} / \overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ Byte Write Control) (32M Page FCRAM)


Note : CE2r must be High for write cycle.

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## - WRITE Timing \#3-4 ( $\overline{\mathrm{WE}} / \overline{\mathrm{LB}} / \overline{\mathrm{UB}}$ Byte Write Control) (32M Page FCRAM)



Note : CE2r must be High for write cycle.

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## - READ / WRITE Timing \#1-1 ( $\overline{\text { CE1r }}$ Control) (32M Page FCRAM)



Note : Write address is valid from either $\overline{\mathrm{CE}} 1 \mathrm{r}$ or $\overline{\mathrm{WE}}$ of last falling edge.

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## - READ / WRITE Timing \#1-2 ( $\overline{\mathrm{CE}} 1 \mathrm{r} / \overline{\mathrm{WE}} / \overline{\mathrm{OE}}$ Control) (32M Page FCRAM)



Note : $\overline{\mathrm{OE}}$ can be Low fixed in write operation under $\overline{\mathrm{CE}} 1 \mathrm{r}$ control $\overline{\mathrm{RD}}-\overline{\mathrm{WR}}-\overline{\mathrm{RD}}$ operation.

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## - READ / WRITE Timing \#2 ( $\overline{\mathrm{OE}}, \overline{\mathrm{WE}}$ Control) (32M Page FCRAM)



Note: $\overline{\mathrm{CE}} 1 \mathrm{r}$ can be tied to Low for $\overline{\mathrm{WE}}$ and $\overline{\mathrm{OE}}$ controlled operation.
When $\overline{\mathrm{CE}} 1 r$ is tied to Low, output is exclusively controlled by $\overline{\mathrm{OE}}$.

## - READ / WRITE Timing \#3 ( $\overline{O E}, \overline{\mathrm{WE}}, \overline{\mathrm{LB}}, \overline{\mathrm{UB}}$ Control) (32M Page FCRAM)



Note : $\overline{\mathrm{CE}} 1 \mathrm{r}$ can be tied to Low for $\overline{\mathrm{WE}}$ and $\overline{\mathrm{OE}}$ controlled operation.
When $\overline{\mathrm{CE}} 1 \mathrm{r}$ is tied to Low, output is exclusively controlled by $\overline{\mathrm{OE}}$.

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## - POWER-UP Timing (32M Page FCRAM)



Note : The tснн specifies after Vccr reaches specified minimum level and applicable both $\overline{\mathrm{CE}} 1 \mathrm{r}$ and CE2r.

## - POWER DOWN Entry and Exit Timing



Note : This Power Down mode can be also used as a reset timing if POWER-UP timing above could not be satisfied and Power-Down program was not performed prior to this reset.

## - Standby Entry Timing after Read or Write (32M Page FCRAM)



Note : Both tchox and tcнwx define the earliest entry timing for Standby mode.
If either of timing is not satisfied, it takes trc (Min) period for Standby mode from $\overline{\mathrm{CE}} 1 \mathrm{r}$ Low to High transition.

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## - POWER DOWN PROGRAM Timing (32M Page FCRAM)


*1 : The all address inputs must be High from Cycle \#1 to \#5.
The address key must confirm the format specified in " $\square 32$ M FCRAM CHARACTERISTICS for MCP 1. Power Down Program Timing ( 32 M Page FCRAM) ". If not, the operation and data are not guaranteed.
*2 : The data key must confirm the format specified in "⿴囗 32 M FCRAM CHARACTERISTICS for MCP 1. Power Down Program Timing ( 32 M Page FCRAM) ". If not, the operation and data are not guaranteed.
*3 : After tcp following Cycle \#6, the Power Down Program is completed and returned to the normal operation.

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- PIN CAPACITANCE

| Parameter | Symbol | Condition | Value |  |  | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: |
|  |  |  |  | Min | Typ |  |
|  |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\mathbb{N}}$ | $\mathrm{V}_{\mathbb{N}}=0$ | - | 11.0 | 14.0 | pF |
| Output Capacitance | Cout | $\mathrm{V}_{\mathrm{OUT}}=0$ | - | 12.0 | 16.0 | pF |
| Control Pin Capacitance | $\mathrm{C}_{\mathbb{N} 2}$ | $\mathrm{~V}_{\mathbb{N}}=0$ | - | 14.0 | 16.0 | pF |
| $\overline{\mathrm{WP}} /$ ACC Pin Capacitance | $\mathrm{C}_{\mathbb{N} 3}$ | $\mathrm{~V}_{\mathbb{N}}=0$ | - | 21.5 | 26.0 | pF |

Note: Test conditions $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}=1.0 \mathrm{MHz}$
■ HANDLING OF PACKAGE
Please handle this package carefully since the sides of package create acute angles.

## CAUTION

- The high voltage ( $\mathrm{V}_{\mathrm{I}}$ ) cannot apply to address pins and control pins except RESET. Exception is when autoselect and sector group protect function are used, then the high voltage ( $\mathrm{V}_{\text {ID }}$ ) can be applied to RESET.
- Without the high voltage ( $\mathrm{V}_{\mathrm{I}}$ ) , sector group protection can be achieved by using "Extended Sector Group Protection" command.
- ORDERING INFORMATION


Device Number/Description
64Mega-bit ( $2 \mathrm{M} \times 16$-bit $+2 \mathrm{M} \times 16$-bit) Dual Operation Page Flash Memory
3.0V-only Read, Program, and Erase

32Mega-bit(2M $\times 16$-bit) Mobile FCRAM

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## PACKAGE DIMENSION



Dimensions in mm (inches)
Note : The values in parentheses are reference values.

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#### Abstract

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